

Photocouplers GaAlAs Infrared LED & Photo Diode

# **TLP3906**

#### 1. Applications

- · Measuring Instruments
- · MOSFET Gate Drivers

#### 2. General

The TLP3906 is a photocoupler in the SO6 package that consists of an infrared light emitting diode optically coupled to a photodiode array. The photodiodes are connected in series, making the TLP3906 suitable for MOS gate drive applications.

#### 3. Features

Open voltage: 7 V (min)
 Short current: 12 μA (min)

(3) Isolation voltage: 3750 Vrms (min)

(4) Safety standards

UL-approved: UL1577, File No.E67349

cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

VDE-approved: EN60747-5-5, EN60065 or EN60950-1 (Note 1)

Note 1: When a VDE approved type is needed, please designate the Option (V4).

Table Short-Circuit Current (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Rank	I <sub>SC</sub> Rank Marking	Test Condition	Short-Circuit Current I <sub>SC</sub> (min)	Unit
C20	С	I <sub>F</sub> = 10 mA	20	μА
None	C, Blank	I <sub>F</sub> = 10 mA	12	

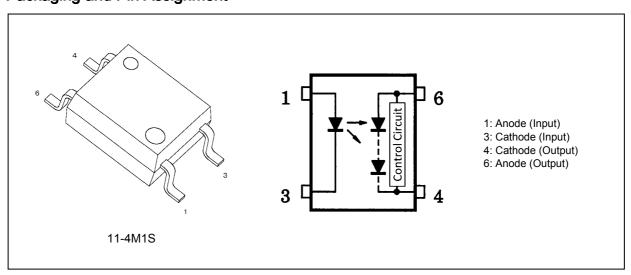
Note: Specify both the part number and a rank in this format when ordering.

Example: TLP3906(C20)

For safety standard certification, however, specify the part number alone.

Example: TLP3906(C20,E(O → TLP3906

### 4. Packaging and Pin Assignment



Start of commercial production



#### 5. Mechanical Parameters

Characteristics	Min	Unit
Creepage distances	5.0	mm
Clearance	5.0	
Internal isolation thickness	0.4	

## 6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

	Characteristics		Symbol	Note	Rating	Unit
LED	Input forward current		I <sub>F</sub>		30	mA
	Input forward current	(T <sub>a</sub> = 125 °C)			10	
	Input forward current derating	$(T_a \ge 100  ^{\circ}C)$	$\Delta I_F/\Delta T_a$		-0.8	mA/°C
	Input power dissipation		$P_{D}$		50	mW
	Input power dissipation derating	(T <sub>a</sub> ≥ 100 °C)	$\Delta P_D/\Delta T_a$		-1.3	mW/°C
	Input reverse voltage		$V_R$		3	V
Detector	Output forward current		I <sub>FD</sub>		50	μА
	Output reverse voltage		$V_{RD}$		10	V
	Output power dissipation	(-40 ≤T <sub>a</sub> ≤ 125 °C)	Po		0.5	mW
Common	Operating temperature		T <sub>opr</sub>		-40 to 125	°C
	Storage temperature		T <sub>stg</sub>		-55 to 125	°C
	Lead soldering temperature	(10 s)	T <sub>sol</sub>		260	°C
	Isolation voltage	AC, 60 s, R.H. ≤ 60 %	BV <sub>S</sub>	(Note 1)	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

### 7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Input forward current	I <sub>F</sub>		_	12	15	mA
Operating temperature	T <sub>opr</sub>		-25	_	100	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

## 8. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	1.5	1.65	1.8	V
	Input reverse current	I <sub>R</sub>		V <sub>R</sub> = 3 V	_		10	μΑ
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	45	_	pF



## 9. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>		V <sub>OC</sub> ≥ 5 V	_	_	3	mA
Open voltage	V <sub>oc</sub>		I <sub>F</sub> = 10 mA	7	9		V
			I <sub>F</sub> = 10 mA, T <sub>a</sub> = 125°C	_	5	_	
Short-circuit current	I <sub>SC</sub>		I <sub>F</sub> = 10 mA	12	30	_	μΑ
			I <sub>F</sub> = 10 mA, T <sub>a</sub> = 125°C	_	12		

## 10. Isolation Characteristics (Unless otherwise specified, $T_a$ = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8		pF
Isolation resistance	Rs	(Note 1)	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	10 <sup>12</sup>	1014		Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	3750	_	_	Vrms
			AC, 1 s in oil	_	10000	_	
			DC, 60 s in oil	_	10000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

## 11. Switching Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>on</sub>		I <sub>F</sub> = 10 mA, C <sub>L</sub> = 1000 pF	_	0.2	1	ms
Turn-off time	t <sub>off</sub>		See Fig. 11.1.	_	0.3	1	

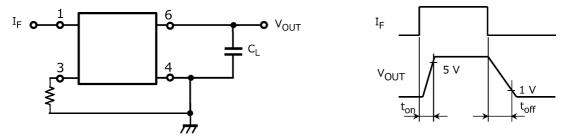


Fig. 11.1 Switching Time Test Circuit, Waveform



## 12. Characteristics Curves (Note)

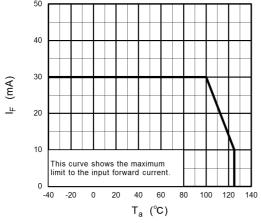


Fig. 12.1 I<sub>F</sub> - T<sub>a</sub>

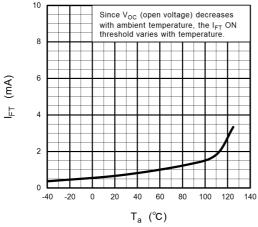


Fig. 12.3 I<sub>FT</sub> - T<sub>a</sub>

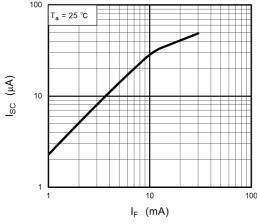


Fig. 12.5 I<sub>SC</sub> - I<sub>F</sub>

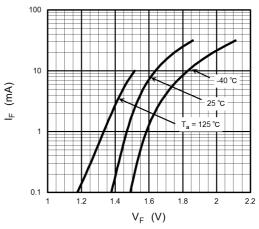


Fig. 12.2 I<sub>F</sub> - V<sub>F</sub>

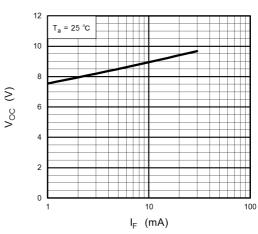


Fig. 12.4 V<sub>OC</sub> - I<sub>F</sub>

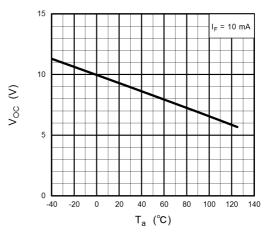
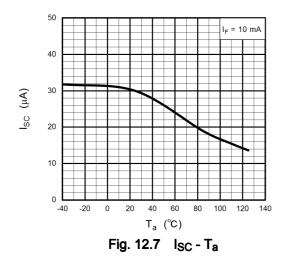


Fig. 12.6 V<sub>OC</sub> - T<sub>a</sub>



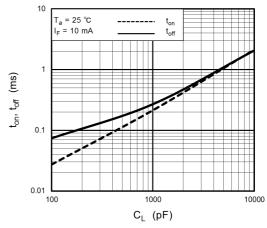


Fig. 12.8 ton, toff - CL

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



#### 13. Soldering and Storage

#### 13.1. Precautions for Soldering

The soldering temperature should be controlled as closely as possible to the conditions shown below, irrespective of whether a soldering iron or a reflow soldering method is used.

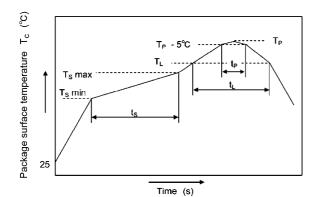
· When using soldering reflow.

The soldering temperature profile is based on the package surface temperature.

(See the figure shown below, which is based on the package surface temperature.)

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.



	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	s
Ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )			3	°C/s
Liquidus temperature	T <sub>L</sub>	2	17	°C
Time above T <sub>L</sub>	t <sub>L</sub>	60	150	S
Peak temperature	T <sub>P</sub>		260	°C
Time during which $T_c$ is between $(T_P - 5)$ and $T_P$	t₽		30	s
Ramp-down rate (T <sub>P</sub> to T <sub>L</sub> )			6	°C/s

Fig. 13.1.1 An example of a temperature profile when lead(Pb)-free solder is used

· When using soldering flow

Preheat the device at a temperature of 150 °C (package surface temperature) for 60 to 120 seconds.

Mounting condition of 260 °C within 10 seconds is recommended.

Flow soldering must be performed once.

· When using soldering Iron

Complete soldering within 10 seconds for lead temperature not exceeding 260 °C or within 3 seconds not exceeding 350 °C

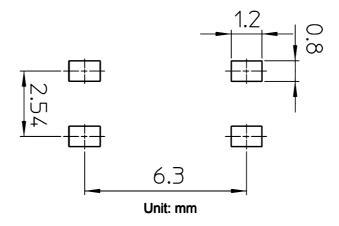
Heating by soldering iron must be done only once per lead.

#### 13.2. Precautions for General Storage

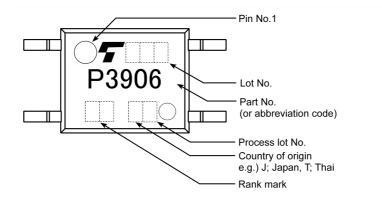
- · Avoid storage locations where devices may be exposed to moisture or direct sunlight
- · Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5  $^{\circ}$ C to 35  $^{\circ}$ C and 45  $^{\circ}$ 6 to 75  $^{\circ}$ 6, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- · When restoring devices after removal from their packing, use anti-static containers.
- · Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.



## 14. Land Pattern Dimensions (for reference only)



## 15. Marking





### 16. EN60747-5-5 Option (V4) Specification

• Part number: TLP3906 (Note 1)

• The following part naming conventions are used for the devices that have been qualified according to option (V4) of EN60747.

Example: TLP3906(V4-TPL,E(O

V4: EN60747 option TPL: Tape type

E: [[G]]/RoHS COMPATIBLE (Note 2)

(O: Domestic ID (Country / Region of origin: Japan)

Note 1: Use TOSHIBA standard type number for safety standard application.

e.g., TLP3906(V4) → TLP3906

Note 2: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Description	Symbol	Rating	Unit
Application classification			_
for rated mains voltage ≤150 Vrms for rated mains voltage ≤300 Vrms		I-IV I-III	
Climatic classification		40 / 125 / 21	_
Pollution degree		2	_
Maximum operating insulation voltage	VIORM	707	Vpeak
Input to output test voltage, Method A $V_{pr}$ = 1.6 × $V_{IORM}$ , type and sample test $t_p$ = 10 s, partial discharge < 5 pC	V <sub>pr</sub>	1131	Vpeak
Input to output test voltage, Method B $V_{pr}$ = 1.875 × $V_{IORM}$ , 100 % production test $t_p$ = 1 s, partial discharge < 5 pC	V <sub>pr</sub>	1325	Vpeak
Highest permissible overvoltage (transient overvoltage, t <sub>pr</sub> = 60 s)	V <sub>TR</sub>	6000	Vpeak
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve)			
current (input current I <sub>F</sub> , P <sub>so</sub> = 0) power (output or total power dissipation) temperature	I <sub>si</sub> P <sub>so</sub> T <sub>s</sub>	250 400 150	mA mW °C
Insulation resistance $V_{IO}$ = 500 V, $T_a$ = 25 °C $V_{IO}$ = 500 V, $T_a$ = 100 °C $V_{IO}$ = 500 V, $T_a$ = $T_s$	R <sub>si</sub>	$\geq 10^{12}$ $\geq 10^{11}$ $\geq 10^{9}$	Ω

Fig. 16.1 EN60747 Insulation Characteristics



Minimum creepage distance	Cr	5.0 mm
Minimum clearance	Cl	5.0 mm
Minimum insulation thickness	ti	0.4 mm
Comparative tracking index	CTI	175

Fig. 16.2 Insulation Related Specifications (Note)

Note: If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value. (e.g., at a standard distance between soldering eye centers of 3.5 mm). If this is not permissible, the user shall take suitable measures.

Note: This photocoupler is suitable for **safe electrical isolation** only within the safety limit data.

Maintenance of the safety data shall be ensured by means of protective circuits.



Fig. 16.3 Marking on packing for EN60747

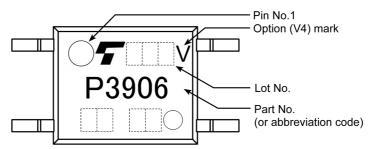
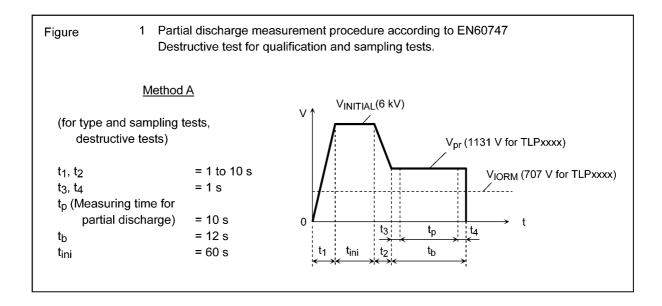
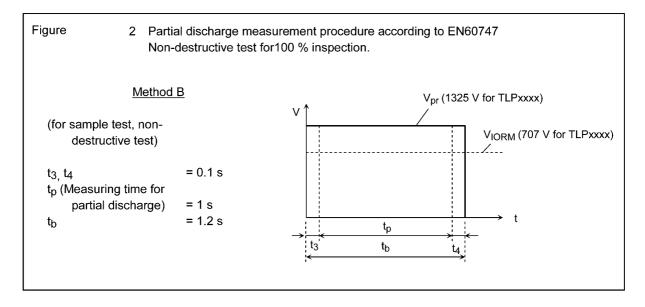


Fig. 16.4 Marking Example (Note)

Note: The above marking is applied to the photocouplers that have been qualified according to option (V4) of EN60747.





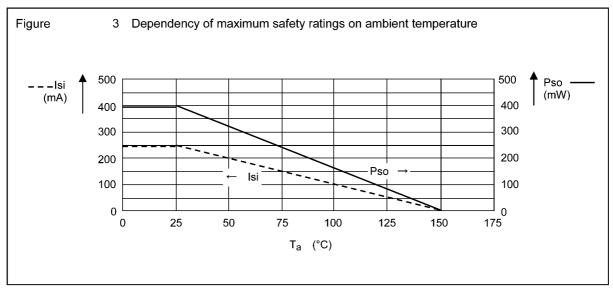


Fig. 16.5 Measurement Procedure



### 17. Embossed-Tape Packing (TP) Specification for Mini-Flat Photocouplers

### 17.1. Applicable Package

Package Name	Product Type
SO6	Photocoupler

#### 17.2. Product Naming Conventions

Type of package used for shipment is denoted by a symbol suffix after a part number. The method of classification is as below.

Example) TLP3906(TPL,E(O

Part number: TLP3906 Tape type: TPL

[[G]]/RoHS COMPATIBLE: E (Note 1)

Domestic ID (Country / Region of origin: Japan): (O

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

#### 17.3. Tape Dimensions Specification

Таре Туре	Division	Packing Amount (A unit per reel)
TPL, TL	L direction	3000
TPR, TR	R direction	3000

#### 17.3.1. Orientation of Device in Relation to Direction of Feed

Device orientation in the carrier cavities as shown in Fig. 17.3.1.1.

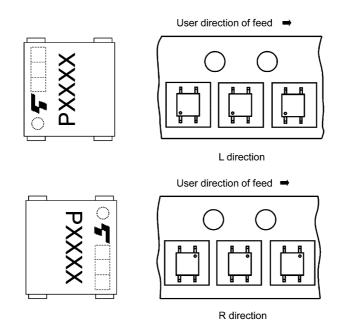


Fig. 17.3.1.1 Device Orientation



## 17.3.2. Empty Cavities

Characteristics	Criterion	Remarks
Occurrences of 2 or more successive empty cavities		Within any given 40-mm section of tape, not including leader and trailer
Single empty cavity	6 devices (max) per reel	Not including leader and trailer

#### 17.3.3. Tape Leader and Trailer

The start end of the tape has 50 or more empty cavities. The hub end of the tape has 50 or more empty cavities and two empty turns only for a cover tape.

#### 17.3.4. Tape Dimensions

Tape material: Plastic (for protection against static electricity)

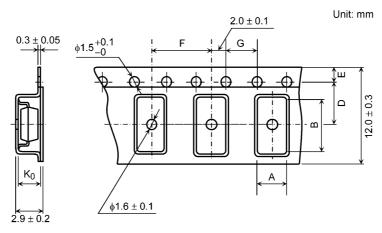


Table Tape Dimensions (unit: mm, tolerance: ±0.1)

Symbol	Dimension	Remark
А	4.0	_
В	7.6	_
D	5.5	Center line of embossed cavity and sprocket hole
E	1.75	Distance between tape edge and sprocket hole center
F	8.0	Cumulative error +0.1/-0.3 (max) per 10 empty cavities holes
G	4.0	Cumulative error +0.1/-0.3 (max) per 10 sprocket holes
K <sub>0</sub>	2.6	Internal space



## 17.3.5. Reel Specification

Material: Plastic

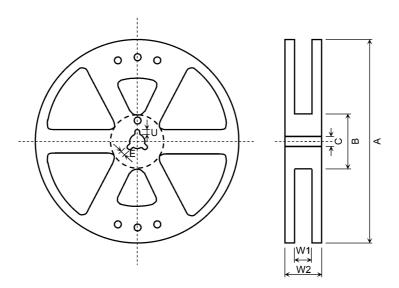
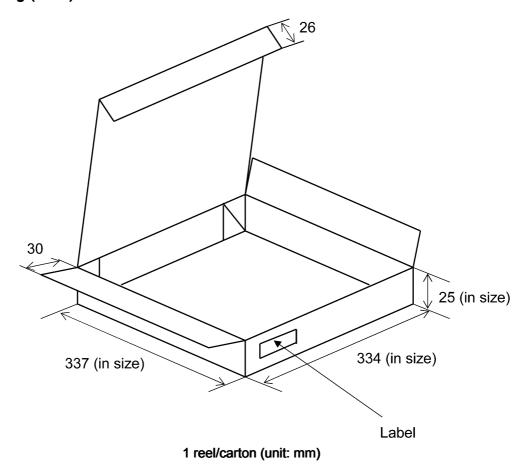


Table Reel Dimensions (unit: mm)

Symbol	Dimension
Α	ф330 ± 2
В	$\phi 80 \pm 1$ or $\phi 100 \pm 1$
С	φ13 ± 0.5
E	2.0 ± 0.5
U	4.0 ± 0.5
W1	$13.5 \pm 0.5$
W2	17.5 ± 1.0



### 17.4. Packing (Note)



Note: Taping reel diameter: \$\phi 330 mm

#### 17.5. Label Format

The carton bears a label indicating the product number, the symbol representing classification of standard, the quantity, the lot number and the Toshiba company name.

#### 17.6. Ordering Information

When placing an order, please specify the part number,  $I_{SC}$  rank, tape type and quantity as shown in the following example.

Example) TLP3906(TPL,E(O 3000pcs

Part number: TLP3906

Tape type: TPL

-

[[G]]/RoHS COMPATIBLE: E (Note)

Domestic ID (Country / Region of origin: Japan): (O Quantity (must be a multiple of 3000): 3000pcs

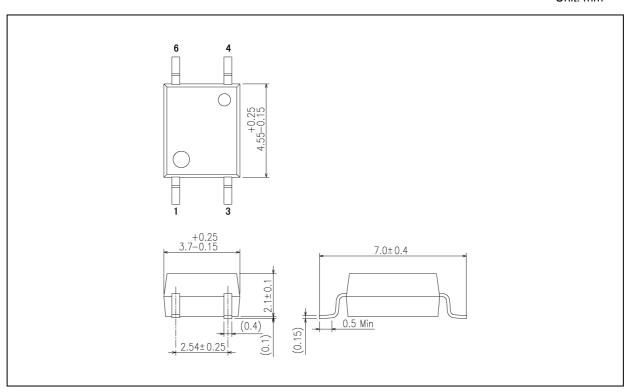
Note: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



## **Package Dimensions**

Unit: mm



Weight: 0.08 g (typ.)

	Package Name(s)
TOSHIBA: 11-4M1S	



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